

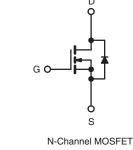
**Vishay Siliconix** 



## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 5.0 V$	0.27			
Q <sub>g</sub> (Max.) (nC)	12				
Q <sub>gs</sub> (nC)	3.0				
Q <sub>gd</sub> (nC)	7.1				
Configuration	Single				





### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$  Specified at  $V_{GS} = 4 V$  and 5 V
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Lead (Pb)-free Availble

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRL520PbF
	SiHL520-E3
SnPb	IRL520
	SiHL520

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25 ^{\circ}C$ , unless otherwise noted							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	100	v		
Gate-Source Voltage			V <sub>GS</sub>	± 10			
Continuous Drain Current	V <sub>GS</sub> at 5.0 V	T <sub>C</sub> = 25 °C		9.2			
		T <sub>C</sub> = 100 °C	ID	6.5	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	36			
Linear Derating Factor				0.40	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	170	mJ		
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	9.2	A		
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	6.0	mJ		
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	PD	60	W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	C		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in		
				1.1	N · m		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 3.0 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AS</sub> = 9.2 A (see fig. 12).

c.  $I_{SD} \leq 9.2$  A,  $dI/dt \leq 110$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 175$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply



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THERMAL RESISTANCE RAT	TINGS									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT				
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 - 2.5								
Case-to-Sink, Flat, Greasd Surface	R <sub>thCS</sub>				°C/W					
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>									
<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ ,	unless otherw	vise noted								
PARAMETER	SYMBOL	TES		IONS	MIN.	TYP.	MAX.	UNIT		
Static										
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	100	-	-	V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.12	-	V/°C		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 μΑ	1.0	-	2.0	V		
Gate-Source Leakage	I <sub>GSS</sub>	Ň	$V_{\rm GS} = \pm 10$	V	-	-	± 100	nA		
Zene Oake Malle en Duch Ourset		V <sub>DS</sub> =	100 V, V <sub>G</sub>	<sub>6</sub> = 0 V	-	-	25			
Zero Gate Voltage Drain Current	ero Gate Voltage Drain Current $I_{DSS}$ $V_{DS} = 80 V$ ,		$V_{GS} = 0 V,$	T <sub>J</sub> = 150 °C	-	-	250	μA		
Durin Davies On Olada Daviatana		V <sub>GS</sub> = 5.0 V	I <sub>D</sub>	= 5.5 A <sup>b</sup>	-	-	0.27			
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 4.0 V$	I <sub>D</sub>	= 4.6 A <sup>b</sup>	-	-	0.38	Ω		
Forward Transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 5.5 A			3.2	-	-	S		
Dynamic					•		•			
Input Capacitance	C <sub>iss</sub>	V – 0.V			-	490	-	pF		
Output Capacitance	C <sub>oss</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V,		-	150	-			
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	0 MHz, see	e fig. 5	-	30	-			
Total Gate Charge	Qg			-	-	12				
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5.0 V		$I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and $13^{\text{b}}$	-	-	3.0	nC		
Gate-Drain Charge	Q <sub>gd</sub>				-	-	7.1			
Turn-On Delay Time	t <sub>d(on)</sub>				-	9.8	-	ns		
Rise Time	t <sub>r</sub>	Voo -	= 50 V, I <sub>D</sub> =	924	-	64	-			
Turn-Off Delay Time	t <sub>d(off)</sub>			, see fig. 10 <sup>b</sup>	-	21	-			
Fall Time	t <sub>f</sub>	-			-	27	-			
Internal Drain Inductance	L <sub>D</sub>	· · · ·	Between lead, 6 mm (0.25") from		-	4.5	-	nH		
Internal Source Inductance	L <sub>S</sub>	die contact			-	7.5	-			
Drain-Source Body Diode Characteristic	s									
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	MOSFET symbol showing the		-	-	9.2	A			
Pulsed Diode Forward Currenta	I <sub>SM</sub>	p - n junction diode			-	-	36			
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25 \ ^{\circ}C, \ I_{S} = 9.2 \ A, \ V_{GS} = 0 \ V^{b}$			-	-	2.5	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	130	190	ns			
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 9.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$			-	0.83	1.0	nC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn			-on is don	ninated by L <sub>S</sub> and L <sub>D</sub> )				

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



I<sub>D</sub>, Drain Current (Amps)

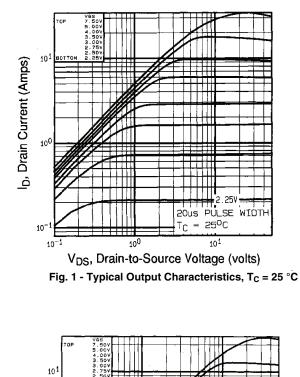
100

10

10

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





V<sub>DS</sub>, Drain-to-Source Voltage (volts)

100

257

20us PULSE WID

175<sup>0</sup>C

101

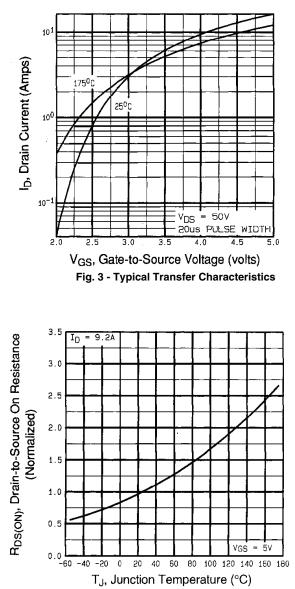


Fig. 4 - Normalized On-Resistance vs. Temperature

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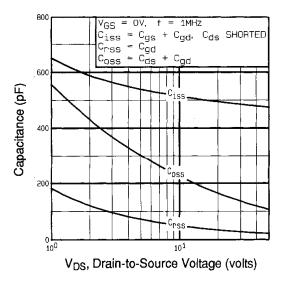


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

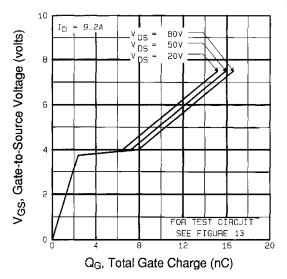


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

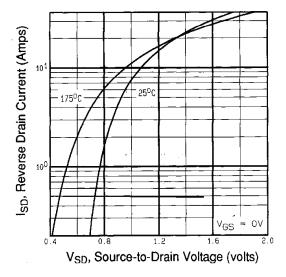


Fig. 7 - Typical Source-Drain Diode Forward Voltage

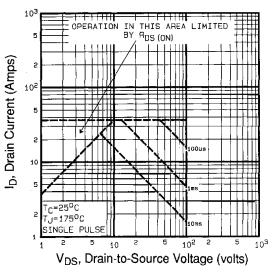


Fig. 8 - Maximum Safe Operating Area

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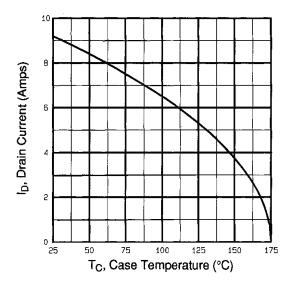


Fig. 9 - Maximum Safe Operating Area

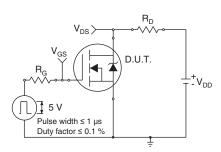


Fig. 10a - Switching Time Test Circuit

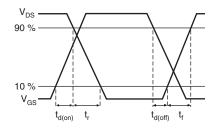
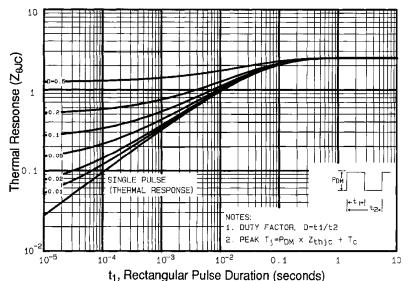
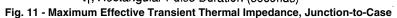


Fig. 10b - Switching Time Waveforms





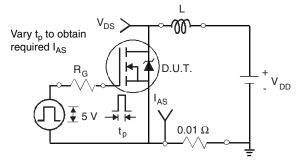


Fig. 12a - Unclamped Inductive Test Circuit

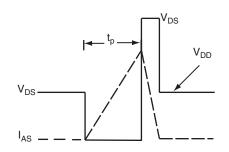


Fig. 12b - Unclamped Inductive Waveforms

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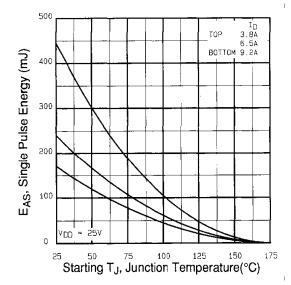


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

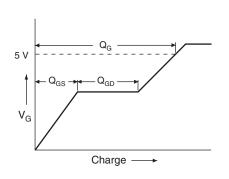


Fig. 13a - Basic Gate Charge Waveform

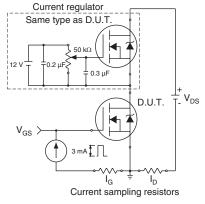
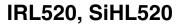
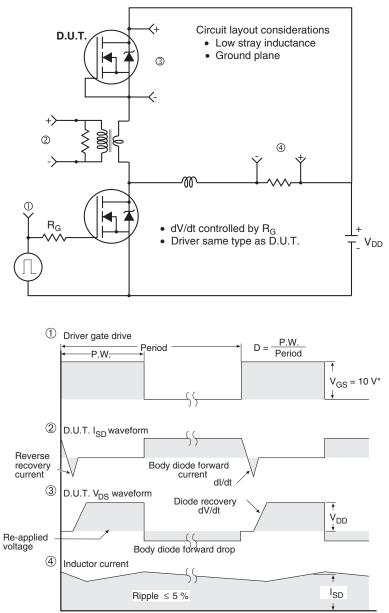


Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit

\*  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91298.



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